

### **SPECIFICATION SHEET**

SPECIFICATION SHEET NO.	Q0531 - XG12M00000L418
DATE	MAY 31, 2023
REVISION	A0
DESCRIPITION	MHz DIP Crystal, L7.9*W3.2*H8.2mm, UM-1 Type, 2 Pins, CA Series
	12.000MHz, +/-30ppm, 18pF, Stability +/-50ppm @Operating Temperature
	Range -40°C ~+85°C, ESR 50 ohm Max,
	Reflow Profile Condition 260 °C Max.
	RoHS/RoHS III compliant
	Package in Bulk
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	TGS CA 12M0A30-18-50-40-50 BLF
PART CODE	XG12M00000L418

VENDOR APPROVE			
Issued/Checked/Approved	So mpope Mandy Xu To V = V	Component Component Control Co	Sumporter Jack
DATE: MAY 31, 2023			
CUSTOMER APPROVE			

DATE:

5/31/2023

1



### **DIP MHZ CRYSTAL UM-1 TYPE 2 PINS CA SERIES**

#### **MAIN FEATURE**

- MHz DIP Crystal, UM-1 Type, L7.9\*W3.2\*H8.2mm, 2pins, CA SERIES
- Low Cost, High precision, High frequency stability
- Cross More Competitors Part
- RoHS/RoHS III compliant

#### APPLICATION

- Measurement Instrument
- Communication Electronics

#### PART CODE GUIDE





XG	12M00000	L	418
1	2	3	4

1) XG: Part family Code for MHz DIP Crystal, L7.9\*W3.2\*H8.2mm, UM-1 Type, 2 Pins, CA series

2) 12M00000: Frequency range code for 12.000MHz

3) L: DIP type, Bulk Package

4) 418: Specification code for original part no. TGS CA 12M0A30-18-50-40-50 BLF

5/31/2023



## DIP MHZ CRYSTAL UM-1 TYPE 2 PINS CA SERIES

### **DIMENSION (Unit: mm)**

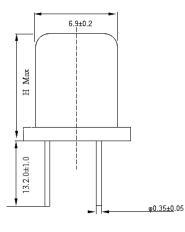
Image for reference



**CA** series

L7.9\*W3.2\*H8.2mm,

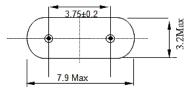
UM-1 Type, H: 8.2mm



Marking

Frequency Range or Internal control code

2.2±0.2



5/31/2023

NextGen Components, Inc.



DIP MHZ CRYSTAL UM-1 TYPE 2 PINS CA SERIES

### **ELECTRICAL PARAMETERS**

Parameter		Part No.	Units	Value			Condition
		Symbol		Min.	Typical	Max.	-
Original	Manufacturer	TGS		TGS (	Crystals		
Holder T	уре	CA			tal, UM-1 Type 18.2mm, 2 Pins		
Frequen	cy Range	12M0	MHz		12.000		
Mode of	f Oscillation	A			AT Fundamenta	I	
Frequen	cy Tolerance	30	ppm	-30		+30	@25°C
Load Cap	pacitance	-18	pF		18		
Stability Tempera	over Operation ance	-50	ppm	-50		+50	
Operatio	on Temperance	-40	°C	-40		+85	
Storage	Temperance		°C	-55		+125	
Equivale Resistan	nt Series ce (ESR)	50	Ω			50	
Drive Le	vel		μW	100		100	
Shunt Ca	apacitance (CO)		pF	0 7.0			
Motiona	ll Capacitance (C1)		fF	N/A			
DLD2			Ω	N/A			
FLD2			ppm	N/A			
RDL2			Ω	N/A			
SPDB			dB	N/A			
Aging			ppm/year			±5	@1 <sup>st</sup> year
Insulatio	on Resistance		MΩ	500			@100Vbc ± 15Vbc
	Package	В		Bulk			
Others	RoHS Status	LF	RoHS III compliant				
	Add Value			Ν	I/A		
	Internal Control Code <mark>*</mark>			N/A			

Note: Original Part Number: TGS CA 12M0A30-18-50-40-50 BLF

5/31/2023



## DIP MHZ CRYSTAL UM-1 TYPE 2 PINS CA SERIES

### RELIABILITY

Test Items	Test Method And Conditions	Specification No:
Shock	Orient the sample in any attitude and drop in three times form a height of 75 cm onto a hardwood board with a thickness of 3 cm	A
Vibration	Subject the sample to 12 minute cycles of frequencies of 10 to 55Hz and amplitudes of 1.5mm fo two hours in each of the x, y and z directions or for 6 hours in total	A
Tesile strength of terminal	apply a 1.5kg tensile load to each terminal and sustain it for 30±5 seconds	A.C
Solderability	Dip terminals in a 230±5°C solder bath for 5±0.5 seconds the solder shall leave an undipped terminal length of 2mm at their base	D
Resistance to Soldering heat	Dip the terminals in a 260±°C solder bath for 10±0.5 seconds the solder shall leave an undipped terminal length of 2mm at their base	A
Leakage test	Take measurements with a heliun leakage	E
Thermal shock	Subject the sample to 5 temperature variation cycles at -40°C for 30 minutes and +100°C for the next 30 minutes in each cycle	A
Cold	Expose the sample in an inoperative mode to 500 hours in a -40°C environment	A

5/31/2023

NextGen Components, Inc.



## DIP MHZ CRYSTAL UM-1 TYPE 2 PINS CA SERIES

### RELIABILITY

Test Items	Test Method And Conditions	Specification No:
Cold	Expose the sample in an inoperative mode to 500 hours in a -40°C environment	A
Dry heat	Expose the sample in an inoperative mode to 500 hours of a +85°C environment	В
Damp heat	Expose the sample in an inoperative mode to 500 hours of a +65°C to 95% RH environment	В
Bending Strength of terminal	Apply a 500g load to one of the terminals and after tilting the main unit resonator for 90°, restore to its original attitude .Then tilt it in an opposite direction for 90°, and restore to its original attitude	A.C



### DIP MHZ CRYSTAL UM-1 TYPE 2 PINS CA SERIES

#### **SPECIFICATIONS**

NO	SPECIFCATIONS REQUESTED
A	Any variation between the pre-and post-test frequencies shall remain within $\pm 5$ ppm , The post-test quivalent series resistance shall pemain within ics specified tolerance range
В	Any variation between the pre-and post-test frequencies shall remain within $\pm 10$ ppm , The post-test quivalent series resistance shall pemain within ics specified tolerance range
с	After each test, no visible damage shall be nanifested, nor shall the hermetic seal break down
D	At least 90% of each dipped area shall be covered by fresh solder
E	The post-test leakage factor shall be 10-7 mbar.1/sec max

### DISCLAIMER

NextGen Components, Inc..reserves the right to make changes to the product(s) and or information contained herein without notice. No liability is assumed as a result of their use or application. No rights under any patent

accompany the sale of any such product(s) or information

### 5/31/2023

NextGen Components, Inc.